

THERMAL CHARACTERISTICS

Rating	Symbol	Value	Unit
Thermal resistance junction-to-case, for IGBT	$R_{ extsf{ heta}JC}$	0.56	°C/~
Thermal resistance junction-to-ambient	$R_{ hetaJA}$	40	°C/~

ELECTRICAL CHARACTERISTICS (T_J = 25°C unless otherwise noted)

Parameter	Test Conditions	Symbol	Min	Тур	Max	Unit
OFF CHARACTERISTICS						
Collector–emitter breakdown voltage, gate–emitter short–circuited	$V_{GE} = 0 V,$ $I_C = 1 mA$	BV _{CES}	650	-	-	V
Temperature Coefficient of Breakdown Voltage	V _{GE} = 0 V, I _C = 1 mA	$\frac{\Delta \text{BV}_{\text{CES}}}{\Delta \text{T}_{\text{J}}}$	-	0.6	-	V/°C
Collector-emitter cut-off current, gate-emitter short-circuited	V _{GE} = 0 V, V _{CE} = 650 V	ICES	_	_	250	μ

TYPICAL CHARACTERISTICS

Figure 7. Capacitance Characteristics

Figure 8. Gate Charge

Figure 9. Turn–On Characteristics vs. Gate Resistance

Figure 10. Turn–Off Characteristics vs. Gate Resistance

Figure 11. Turn–On Characteristics vs. Collector Current Figure 12. Turn–Off Characteristics vs. Collector Current



onsemi, , and other names, marks, and brands are registered and/or common law trademarks of Semiconductor Components Industries, LLC dba "onsemi" or its affiliates and/or subsidiaries in the United States and/or other countries. onsemi owns the rights to a number of patents, trademarks, copyrights, trade secrets, and other intellectual property. A listing of onsemi's product/patent coverage may be accessed at www.onsemi.com/site/pdf/Patent-Marking.pdf. Onsemi reserves the right to make changes at any time to any products or information herein, without notice. The information herein is provided "as-is" and onsemi makes no warranty, representation or guarantee regarding the accuracy of the information, product features, availability, functionality, or suitability of its products for any particular purpose, nor does onsemi assume any liability arising out of the application or use of any product or incruit, and specifically disclaims any and all liability, including without limitation special, consequential or incidental damages. Buyer is responsible for its products and applications using onsemi